

PRODUCT DESCRIPTION

Modified epoxy | 2 part | solvent-free | room temperature/heat-curing

- Bonding, coating and potting of metals, glass and plastics
- Good oil, chemical and moisture resistance
- Low shrinkage
- Low water absorption
- Good adhesion to metal, glass and plastics

CURING PROPERIES

This product is a two-component adhesive. The adhesive can be applied after mixing the two components in their appropriate ratios. All two-component adhesives have a determined pot life. Consideration should be given to the amount of adhesive that is mixed, as it must be applied within the noted pot life for optimal dispensing and assembly.

If static mixers are used, we recommend Quadro mixers with 24 elements to achieve sufficient mixing.

Mixing ratio	Pot life
2:1	1 h

This adhesive can be cured at room temperature or more rapidly with heat. Typical curing temperatures are listed in the table below.

Temperatures	Time
25°C	12 h
80°C	30 min

The heat cure times are only provided as a guideline. They are derived from curing a 2g adhesive sample without affixed substrates in a laboratory environment. Actual cure times can vary based on part size, configuration, adhesive volume, temperature control, and the time required for the component substrates to attain oven temperature.

The final bond strength of the adhesive is achieved no sooner than 24 h after the bonded components are removed from the oven.



TECHNICAL DATA	
Resin	Epoxy
Appearance	Black
Uncured Material	
Viscosity mix [mPas] (Kinexus Rheometer, 25 °C, 10s ⁻¹)	12,000 – 22,000
Test instruction P064	12,000 – 22,000
Viscosity part A [mPas] (Kinexus Rheometer, 25 °C, 10s ⁻¹) Test instruction P064	10,000 – 20,000
Viscosity part B [mPas] (Kinexus Rheometer, 25 °C, 10s ⁻¹) Test instruction PO64	18,000 – 29,000
Thixotropic index mix [1/10]	11 10
Test instruction P064	1.1 – 1.2
Density [g/cm³]	11
Test instruction P004	1.1
Cured Material	
Hardness shore D	
80°C, 60min	70 – 80
Test instruction P006	
Typical operating temperature [°C]	-40 - 180
Linear shrinkage [%]	
80°C, 60min	<1
Test instruction PO31	
Water absorption [wt%]	.1.5
80°C, 60min Test instruction P016	<1.5
Glass transition temperature - DSC [°C]	
80°C, 60min	60 – 70
Test instruction P009	
Coefficient of thermal expansion [ppm/K] below Tg	50 - 80
Test instruction P017	30 – 60
Coefficient of thermal expansion [ppm/K] above Tg	
80°C, 60min	225 - 275
Test instruction P017	
Thermal conductivity [W/m*K]	
Test instruction P062	0.2 – 0.3
Dielectric strength [kV/mm]	22 26
IEC 60243-1	32 - 36
Comparative tracking index CTI-value IEC 60112:2020	600
Young's modulus – Tensile test [MPa]	
80°C, 60min	1,000 – 2,500
Test instruction P056	
Tensile strength [MPa]	
80°C, 60min	20 – 25
Test instruction P014	



Elongation at break [%] 80°C, 60min Test instruction P014	2 – 5
Lap shear strength (stainless steel/stainless steel) [MPa] 80°C, 30min Test instruction P013	19 – 23
Lap shear strength (Al 2024/Al 2024) [MPa] 80°C, 30min Test instruction P013	12 – 15
Lap shear strength (PA6 GF/PA6 GF) [MPa] 80°C, 30min Test instruction P013	6 – 10

TRANSPORT/STORAGE/SHELF LIFE

Package type	Transport	Storage	Shelf life*
Syringe/Cartridge	At room temperature max. 25°C	At room temperature min	At delivery min. 6 months
Other packages			max. 12 months

^{*}Store in original, unopened containers!



INSTRUCTIONS FOR USE

Surface preparation

The surfaces to be bonded should be free of dust, oil, grease, mold release, or other contaminants in order to obtain an optimal and reproducible bond. For cleaning we recommend the cleaner IP® from Hoenle, or a solution of Isopropyl Alcohol at 90% or higher concentration. Substrates with low surface energy (e.g. polyethylene, polypropylene) must be pretreated in order to achieve sufficient adhesion.

Application

Our products are supplied ready to use. Depending on packaging they can be applied by hand directly from the container or by using compatible dispensing systems and automation. Many commercially available valve and controller options are available to ensure accurate and consistent adhesive dispensing. For assistance with dispensing and curing questions, please contact our Applications Engineering department. To obtain best results, the adhesive and substrates to be bonded may not be cold and should be allowed to warm to room temperature prior to processing. For safety information refer to our Material Safety Data Sheet (MSDS).

Storage

Store uncured product in its original, closed container in a dry location. Any material removed from the original container must not be returned to the container as it could be contaminated. Hoenle cannot assume responsibility for products that were improperly stored, contaminated, or repackaged into other containers.

Handling and Clean-up

For safe handling information, consult this product's Material Safety Data Sheet (MSDS) prior to use. Uncured material may be wiped away from surfaces with organic solvents. Do not use solvents to remove material from eyes or skin!



DISCLAIMER

The product is free of heavy metals, PFOS and Phthalates and is conform to the current EU-Directive RoHS.

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CONTACT

Hoenle Adhesives GmbH | Stierstädter Straße 4 | 61449 Steinbach | Germany T: +49 6171 6202-0 | adhesivesystems@hoenle.com

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